# NPN SILICON GERMANIUM RF TRANSISTOR **NESG2046M33**

# NPN SIGE RF TRANSISTOR FOR LOW NOISE, HIGH-GAIN AMPLIFICATION 3-PIN SUPER LEAD-LESS MINIMOLD (M33, 0804 PACKAGE)

#### FEATURES

NEC

- The device is an ideal choice for low noise, high-gain amplification NF = 0.8 dB TYP., Ga = 11.5 dB TYP. @ VcE = 1 V, Ic = 3 mA, f = 2 GHz
- High breakdown voltage technology for SiGe Tr. adopted: VCEO (absolute maximum ratings) = 5.0 V
- 3-pin super lead-less minimold (M33, 0804 package)

#### ORDERING INFORMATION

Part Number	Quantity	Supplying Form	
NESG2046M33	50 pcs (Non reel)	• 8 mm wide embossed taping	
NESG2046M33-T3	10 kpcs/reel	Pin 2 (Base) face the perforation side of the tape	

**Remark** To order evaluation samples, contact your nearby sales office. Unit sample quantity is 50 pcs.

#### ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	13	V
Collector to Emitter Voltage	VCEO	5	V
Emitter to Base Voltage	Vebo	1.5	V
Collector Current	lc	40	mA
Total Power Dissipation	Ptot Note	130	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-65 to +150	°C

**Note** Mounted on 1.08  $\text{cm}^2 \times 1.0 \text{ mm}$  (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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# ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	Ісво	Vсв = 5 V, IE = 0 mA	-	-	100	nA
Emitter Cut-off Current	Іево	VEB = 0.5 V, Ic = 0 mA	-	-	100	nA
DC Current Gain	hfe <sup>Note 1</sup>	Vce = 1 V, Ic = 2 mA	140	180	220	-
RF Characteristics						
Gain Bandwidth Product	fт	Vce = 1 V, Ic = 15 mA, f = 2 GHz	15	18	-	GHz
Insertion Power Gain	$ S_{21e} ^2$	Vce = 1 V, Ic = 15 mA, f = 2 GHz	11	13	-	dB
Noise Figure	NF	$\label{eq:Vce} \begin{array}{l} V_{CE} = 1 \ V, \ I_C = 3 \ mA, \ f = 2 \ GHz, \\ Z_S = Z_{Sopt}, \ Z_L = Z_{Lopt} \end{array}$	_	0.8	1.5	dB
Associated Gain	Ga	$\label{eq:Vce} \begin{array}{l} V_{CE} = 1 \ V, \ I_C = 3 \ mA, \ f = 2 \ GHz, \\ Z_S = Z_{Sopt}, \ Z_L = Z_{Lopt} \end{array}$	9.5	11.5	-	dB
Reverse Transfer Capacitance	Cre <sup>Note 2</sup>	Vсв = 1 V, IE = 0 mA, f = 1 MHz	-	0.2	0.4	pF

Notes 1. Pulse measurement: PW  $\leq 350~\mu s,$  Duty Cycle  $\leq 2\%$ 

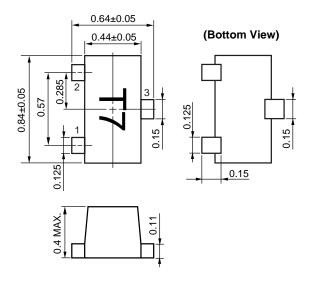
2. Collector to base capacitance when the emitter grounded

### **hfe CLASSIFICATION**

Rank	FB			
Marking	Τ7			
hfe Value	140 to 220			

# PACKAGE DIMENSIONS

## 3-PIN SUPER LEAD-LESS MINIMOLD (M33, 0804 PACKAGE) (UNIT: mm)



#### **PIN CONNECTIONS**

- 1. Emitter
- 2. Base
- 3. Collector

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